

APPROVAL SHEET

SHENZHEN PUWEI TECHNOLOGY CO.,LTD.

PURE-V
TECH



Product Description: SAW Filter 1645 MHz SMD 3.0×3.0mm (BW=65.0MHz)

Part No.	PV6G45B
Pages	7
Date	2022/04/12
Revision	2.0



REACH

Prepared by:	
Checked by:	张杨
Approved by:	

History Record

Date	Part No.	Version No.	Modify Content	Remark
2022.04.12	PV6G45B	2.0	指标、频谱图更新	

Application

- Low-loss SAW component
- Low amplitude ripple
- Sharp rejections at both out-bands
- Usable passband 65 MHz

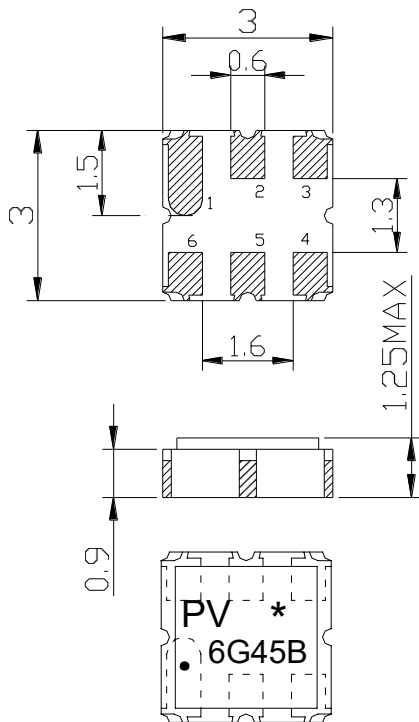
Features

- RoHS compatible
- Package size 3.00x3.00x1.25mm³
- Package Code DCC6C
- Electrostatic Sensitive Device(ESD)

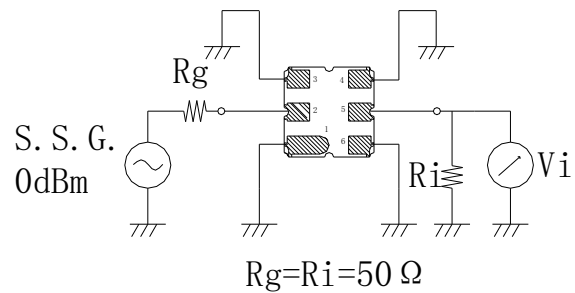
Maximum Rating

Item		Value	Unit
DC Voltage	V_{DC}	5	V
Operation Temperature	T	-40 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +85	°C
RF Power Dissipation	P	20	dBm

Package Dimensions (Unit: mm)



Test Circuit (Bottom View)



Pin Configuration

2	Input
5	Output
1, 3, 4, 6	Ground

- Top View, Laser Marking

- **PV** : Manufacturer's mark **"6G45B"** : Part number **"·"** : Terminal 1
- **"*"** : Lot number (The code shown below varies in a 4-year cycle)

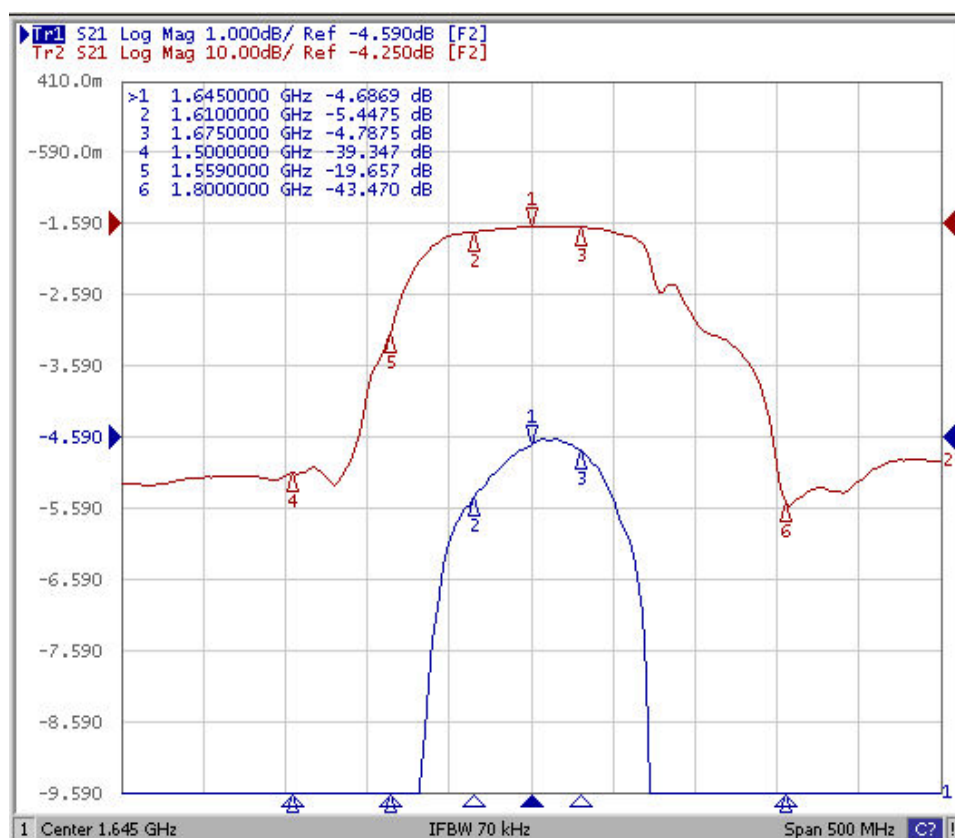
Code	1	2	3	4	5	6	7	8	9	10	11	12
2021	a	b	c	d	e	f	g	h	i	j	k	m
2022	n	p	q	r	s	t	u	v	w	x	y	z
2023	A	B	C	D	E	F	G	H	J	K	L	M
2024	N	P	Q	R	S	T	U	V	W	X	Y	Z

Electronic Characteristics Test Temperature: 25°C ± 2°C

Terminating source impedance: 50 Ω

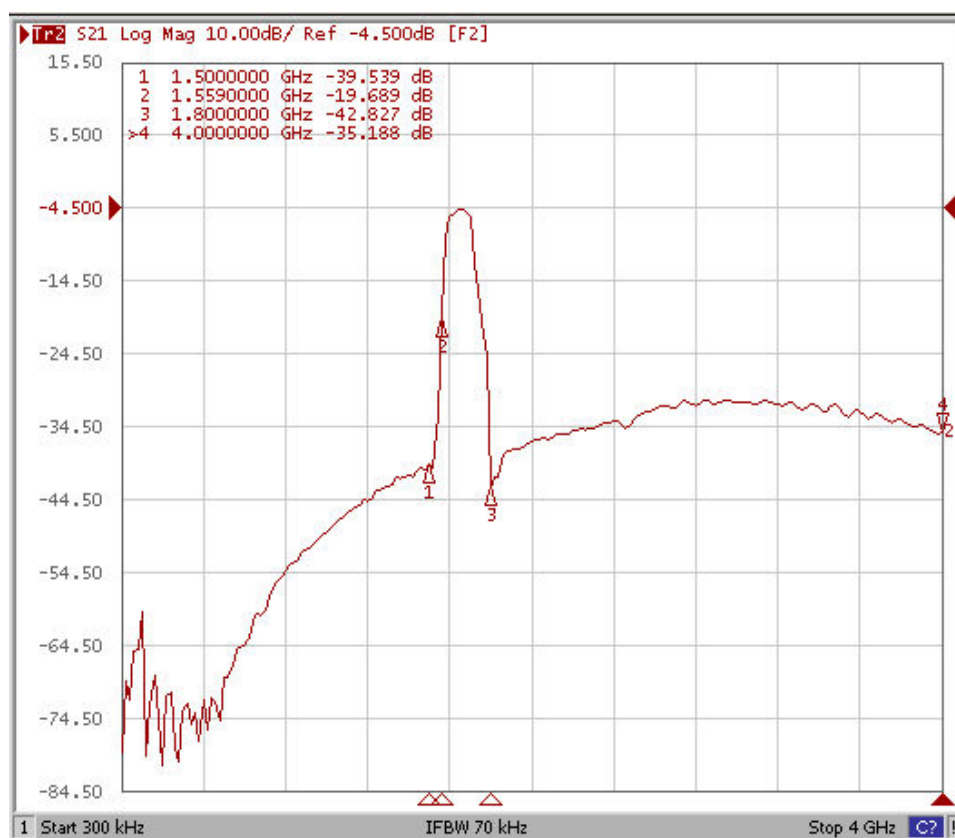
Item		Minimum	Typical	Maximum	Unit
Center Frequency	fc		1645.0		MHz
Insertion Loss(min)	IL		4.2	5.0	dB
Amplitude Ripple (p-p)	1610.00 - 1675.00 MHz	$\Delta\alpha$	0.8	1.0	dB
Group Delay Ripple	1610.00 - 1675.00 MHz	GDR	5.0	15.0	ns
Absolute Attenuation		α			
	DC - 1500.00 MHz	38.0	40.0		dB
	1500.00 - 1559.00 MHz	16.0	18.0		dB
	1800.00 - 4000.00 MHz	28.0	30.0		dB
Input VSWR	1610.00 - 1675.00 MHz		1.5:1	2.0:1	/
Output VSWR	1610.00 - 1675.00 MHz		1.5:1	2.0:1	/

Frequency Characteristics

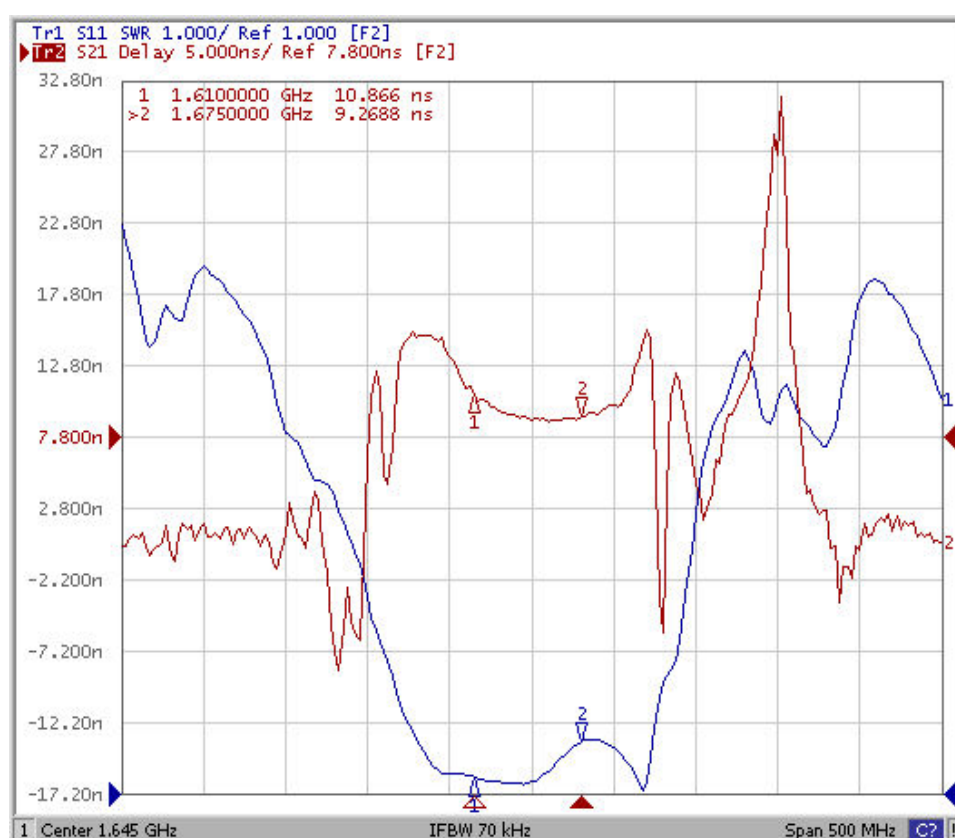


Frequency Characteristics

Frequency Response (wideband)



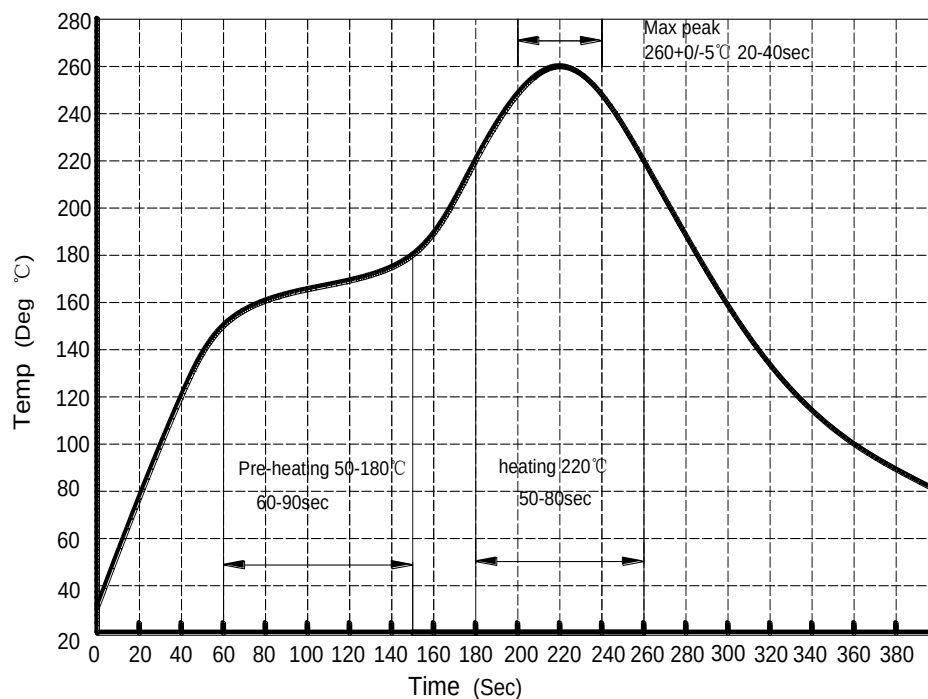
Delay Ripple & S11 VSWR



Reliability (The SAW components shall remain electrical performance after tests)

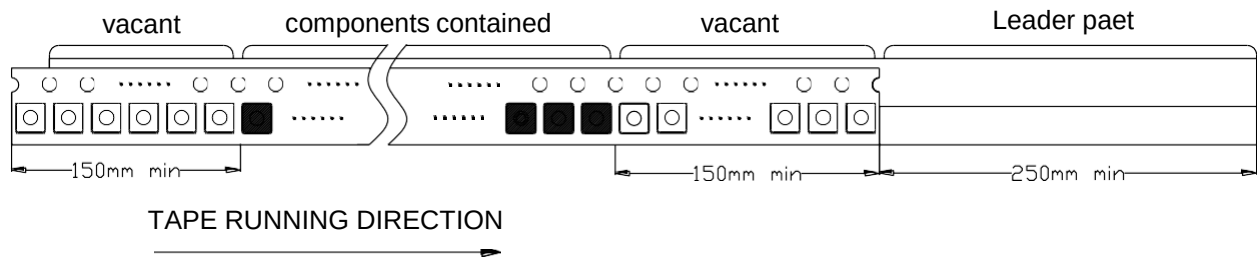
No.	Test item	Test condition
1	Temperature Storage	(1) Temperature: 85°C±2°C , Duration: 250h , Recovery time:2h±0.5h (2) Temperature: -55°C±3°C , Duration: 250h ,Recovery time:2h±0.5h
2	Humidity Test	Conditions: 60°C±2°C , 90~95% RH Duration: 250h
3	Thermal Shock	Heat cycle conditions: TA=-55°C±3°C, TB=85°C±2°C, t1=t2=30min, Switch time: ≤3min, Cycle time: 100 times, Recovery time: 2h ± 0.5h.
4	Vibration Fatigue	Frequency of vibration: 10~55Hz Amplitude:1.5mm Directions: X,Y and Z Duration: 2h
5	Drop Test	Cycle time: 10 times Height: 1.0m
6	Solder Ability Test	Temperature: 245°C±5°C Duration: 3.0s--5.0s Depth: DIP--2/3 , SMD--1/5
7	Resistance to Soldering Heat	(1) Thickness of PCB:1mm , Solder condition: 260°C±5°C , Duration:10±1s (2) Temperature of Soldering Iron: 350°C±10°C, Duration:3~4s, Recovery time : 2 ±0.5h

Recommended Reflow Soldering Diagram



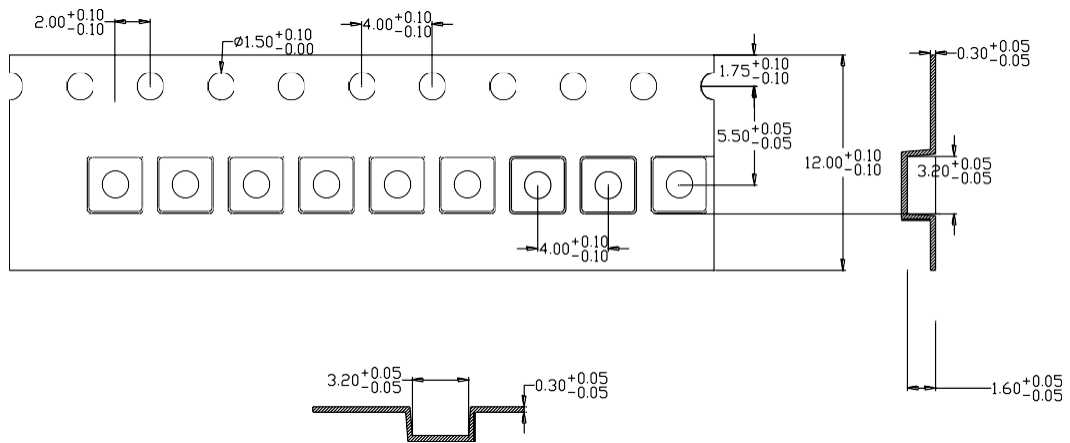
Packing Information

Carrier Tape



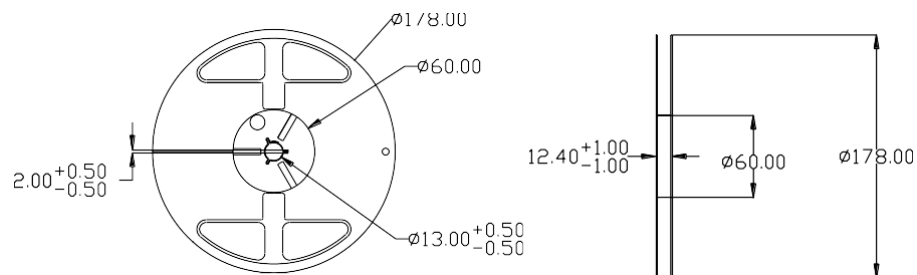
Reel Dimensions

Unit: mm



Outer Packing

Unit: mm



Notes

1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.
2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
4. Only leads of component may **be soldered**. Please avoid soldering another part of component.
5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.